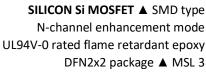






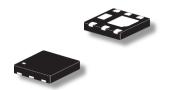


#### 20V Δ 16.5mΩ Δ 8A Δ Si MOSFET



Super high dense cell density for extremely low R<sub>DS(ON)</sub>

With ESD diode between Gate and Source





### **MAXIMUM RATINGS**

Parameter (T <sub>A</sub> = 25°C, unless otherwise noted)	Characteristics	
Drain-Source Voltage	V <sub>DS</sub>	20V
Gate-Source Voltage	V <sub>GS</sub>	±12V
Continuous Drain Current	I <sub>D</sub>	8A
Pulsed Drain Current Note 1	I <sub>DM</sub>	32A
Maximum Power Dissipation	P <sub>D</sub>	2W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55°C to +150°C

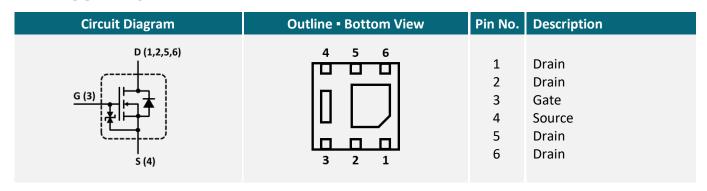
#### THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Ambient Note 2	R <sub>TH_JA</sub>	62.5°C/W

### **APPLICATIONS**

Battery	DC	Load	Power	USB
Pack	Fan	Switches	Banks	Storage
+4-			4	<b>Y</b>

## **PIN DESCRIPTION**





# **ELECTRICAL CHARACTERISTICS** ▲ T<sub>C</sub> = 25°C, unless otherwise noted

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$ , $I_D = 250\mu A$	$BV_{DSS}$	20			V
Zero Gate Voltage Drain Current	$V_{DS} = 20V$ , $V_{GS} = 0V$	I <sub>DSS</sub>			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS} = 12V$ , $V_{DS} = 0V$	$I_{GSSF}$			10	μΑ
Gate Body Leakage Current, Reverse	$V_{GS} = -12V, V_{DS} = 0V$	$I_{GSSR}$			-10	μΑ
On Characteristics Note 3						
Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_{D} = 250 \mu A$	$V_{GS(th)}$	0.5		1.2	V
Static Drain-Source On-Resistance	$V_{GS} = 4.5V, I_D = 5A$	R <sub>DS(ON)</sub>		16.5	20	mΩ
Static Drain-Source On-Resistance	$V_{GS} = 2.5V$ , $I_D = 4A$	R <sub>DS(ON)</sub>		21.5	28	mΩ
Dynamic Characteristics Note 4						
Input Capacitance	$V_{DS} = 10V$ , $V_{GS} = 0V$ , $f = 1MHz$	C <sub>ISS</sub>		45		pF
Output Capacitance	$V_{DS} = 10V$ , $V_{GS} = 0V$ , $f = 1MHz$	Coss		130		pF
Reverse Transfer Capacitance	$V_{DS} = 10V$ , $V_{GS} = 0V$ , $f = 1MHz$	C <sub>RSS</sub>		15		pF
Switching Characteristics Note 4						
Turn-On Delay Time	$V_{DD} = 10V$ , $V_{GS} = 5V$ , $I_D = 6.5A$ , $R_{G(ext)} = 3\Omega$	t <sub>D(ON)</sub>		0.35		ns
Turn-On Rise Time	$V_{DD}$ = 10V, $V_{GS}$ = 5V, $I_{D}$ = 6.5A, $R_{G(ext)}$ = 3 $\Omega$	$t_R$		0.8		ns
Turn-Off Delay Time	$V_{DD} = 10V$ , $V_{GS} = 5V$ , $I_D = 6.5A$ , $R_{G(ext)} = 3\Omega$	t <sub>D(OFF)</sub>		2.49		ns
Turn-Off Fall Time	$V_{DD}$ = 10V, $V_{GS}$ = 5V, $I_D$ = 6.5A, $R_{G(ext)}$ = 3 $\Omega$	t <sub>F</sub>		1.55		ns
Total Gate Charge	$V_{DS} = 10V$ , $V_{GS} = 4.5V$ , $I_D = 6.5A$	$Q_{G}$		3.89		nC
Gate Source Charge	$V_{DS} = 10V$ , $V_{GS} = 4.5V$ , $I_D = 6.5A$	$Q_{GS}$		0.92		nC
Gate Drain Charge	$V_{DS} = 10V$ , $V_{GS} = 4.5V$ , $I_D = 6.5A$	$Q_{GD}$		1.85		nC
<b>Drain-Source Diode Characteristics a</b>	nd Maximum Ratings					
Drain-Source Diode Forward Current Note 2		I <sub>S</sub>			1.6	Α
Drain-Source Diode Forward Voltage Note 3	$V_{GS} = 0V$ , $I_S = 1.5A$	$V_{SD}$			1.2	V

#### Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Surface Mounted on FR4 Board, t ≤ 10 sec
- 3: Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4: Guaranteed by design, not subject to production testing.



#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

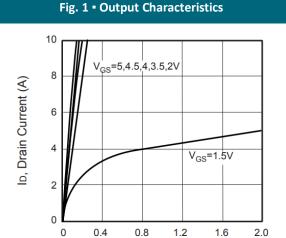
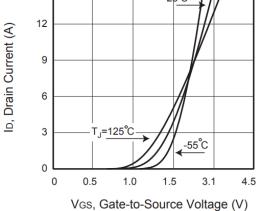




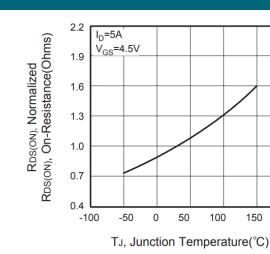
Fig. 2 • Transfer Characteristics



VDS, Drain-to-Source Voltage (V)

Fig. 3 • Capacitance

Fig. 4 • On-Resistance Variation with Temperature



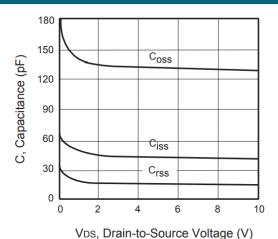
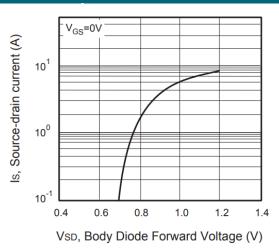


Fig. 5 • Gate Threshold Variation with Temperature

V<sub>DS</sub>=V<sub>GS</sub> Gate-Source Threshold Voltage I<sub>D</sub>=250μA 1.2 Vтн, Normalized 1.1 1.0 0.9 0.8 0.7 0.6 -50 0 25 50 75 100 125 150 TJ, Junction Temperature(°C)

Fig. 6 • Body Diode Forward Voltage Variation with Source Current



MGT ▲ Manufacturer Group of Technology

150

200



#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

Fig. 7 • Gate Charge

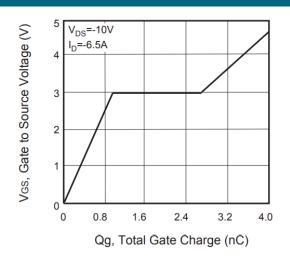


Fig. 8 • Maximum Safe Operating Area

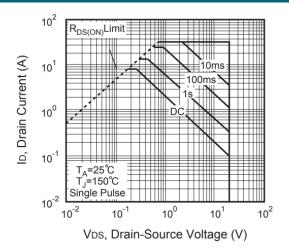
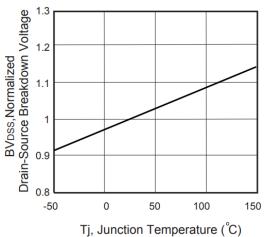


Fig. 9 • Breakdown Voltage Variation vs. Temperature





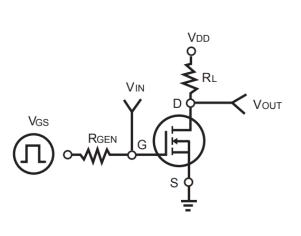
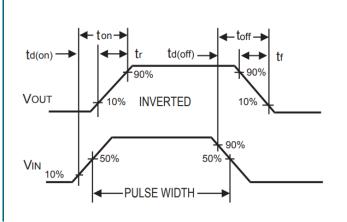


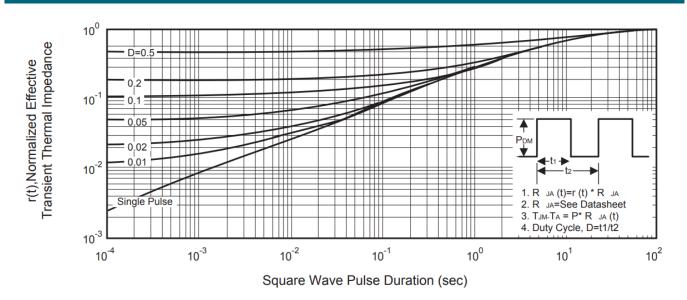
Fig. 11 • Switching Waveforms



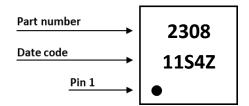


#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

Fig. 12 • Normalized Thermal Transient Impedance Curve



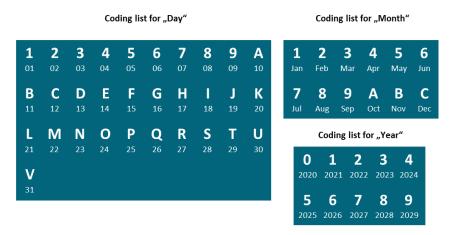
#### **PART MARKING**



#### **DATE CODE**

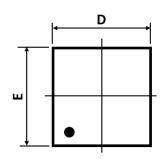
Example: 11S4Z

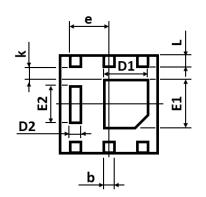


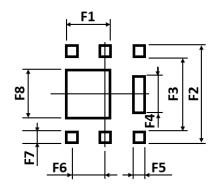


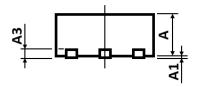


## PACKAGE OUTLINE AND RECOMMENDED PAD LAYOUT









Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
Α	0.700	-	0.800
A1	0.000	-	0.050
А3		0.203 (REF)	
D	1.924	-	2.076
E	1.924	-	2.076
D1	0.800	-	1.000
F1	0.850	_	1.050

Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
D2	0.200	-	0.400
E2	0.460	-	0.660
k		0.200 (MIN)	
b	0.250	-	0.350
е		0.650 (TYP)	
L	0.174	-	0.326

Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
F1	-	1.000	-
F2	-	2.300	-
F3	-	1.350	-
F4	-	0.660	-

Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
F5	-	0.400	-
F6	-	0.650	-
F7	-	0.470	-
F8	-	1.050	-

Notes: 1. The suggested land pattern dimensions have been provided for reference only.

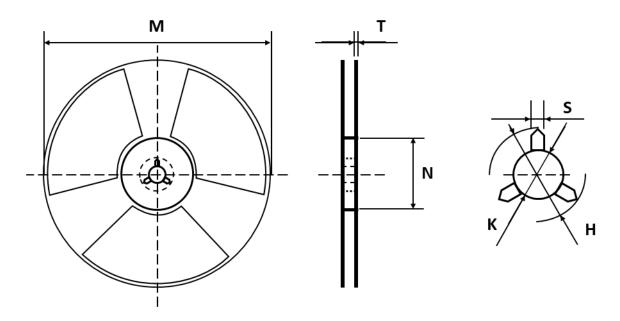
2. For further information, please reference document IPC-7351A.

### **ORDERING INFORMATION**

Part Number	Package	Packing	Reel Qty.	Inner Box Qty.
CEC2308	DFN 2x2	Reel	3,000pcs	30,000pcs

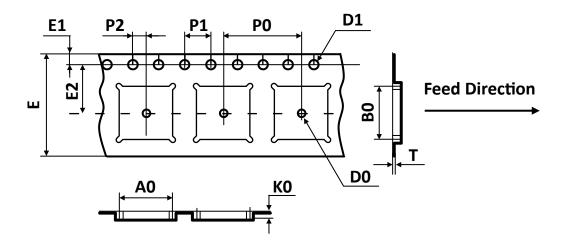


## **REEL DIMENSIONS** ▲ All dimensions in mm



Tape Size	Reel Size	M	N	Т	H	K	S
12mm	Ø180	Ø178.00	Ø54.00	1.20	20.00	13.30	3.00
12mm	<i>9</i> 160	±1.00	±0.50	±0.20	±1.00	±0.30	±1.00

## **TAPE DIMENSIONS** ▲ All dimensions in mm

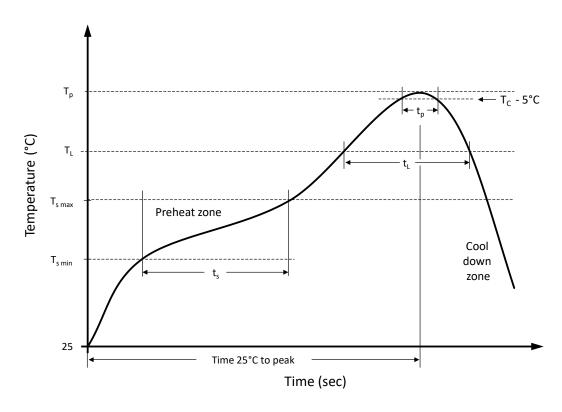


Package	A0	В0	КО	D0	D1	E	E1	E2	Р0	P1	P2	T
DFN 2x2	2.30	2.30	1.10	1.50	1.50	12.00	1.75	5.50	8.00	4.00	2.00	0.23
DFIN ZXZ	±0.10	±0.10	±0.15	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.05	±0.02

Note: All dimensions meet EIA-481-D requirements.



## RECOMMENDED REFLOW SOLDERING PROFILE



## **Recommended reflow soldering conditions** ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	$T_{s min}$	100 °C	150 °C
Preheat temperature max.	T <sub>s max</sub>	150 °C	200 °C
Preheat time t <sub>s</sub> from T <sub>s min</sub> to T <sub>s max</sub>	ts	120 seconds	120 seconds
Ramp-up rate (T₁ to Tp)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	$T_L$	183 °C	217 °C
Time t <sub>L</sub> maintained above T <sub>L</sub>	t <sub>L</sub>	150 seconds max.	150 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	t <sub>p</sub>	20 seconds max.	30 seconds max.
Ramp-down rate (T <sub>L</sub> to T <sub>p</sub> )		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes



#### **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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